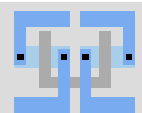
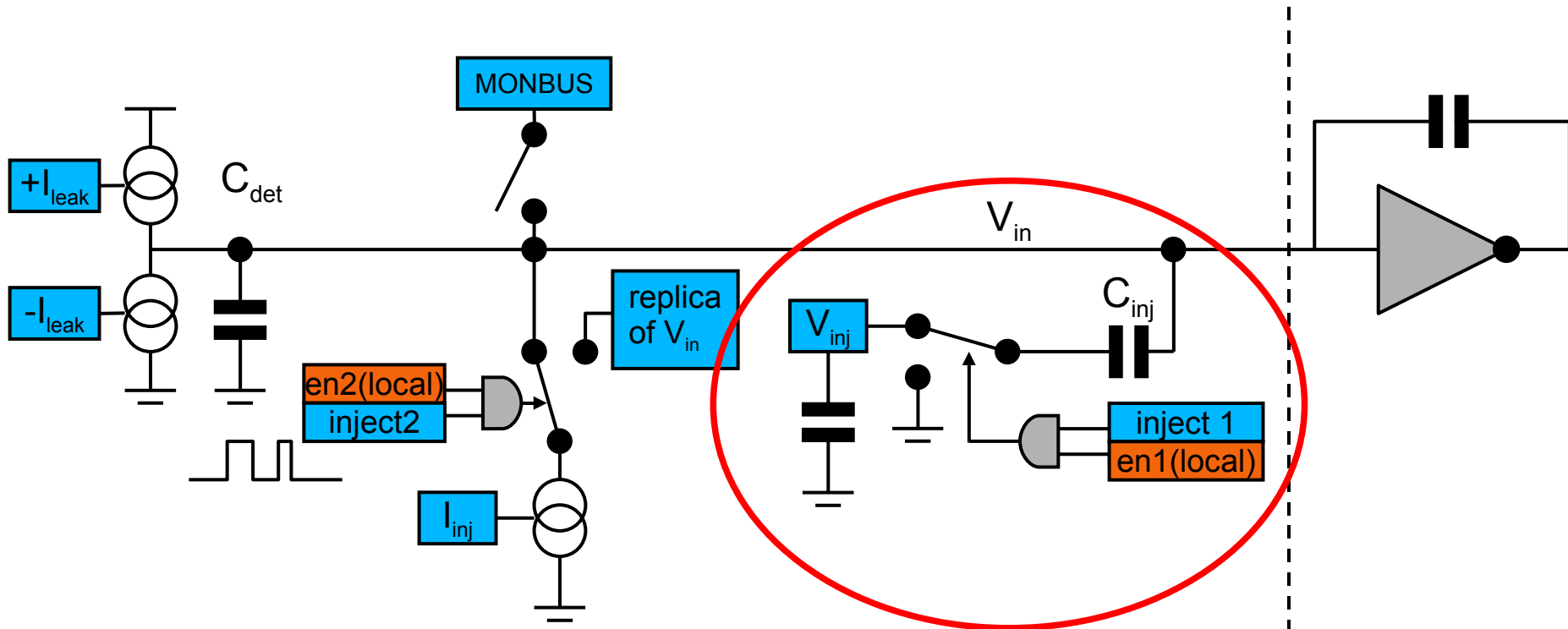


Design carefully: Injection Circuit

- Goals:
 - Full chip characterization without external components
 - Measure Noise
 - fine steps up to $\sim 1/2$ mip
 - calibrated charge
 - Inject known step through known injection capacitor C_{inj} : $Q_{inj} = C_{inj} \times dV$
 - Measure dynamic range and (linearity)
 - larger steps up to ~ 4 mip
 - Measure timing and double pulse behavior
 - requires more than one step or – better – current pulses: $Q_{inj} = I_{inj} \times dT$
 - Measure tricky details
 - i.e. measure crosstalk: inject one channel, measure thres/noise on neighbor
 - Inject leakage current, measure leakage current
 - Versatile Monitoring Bus



Possible Circuit



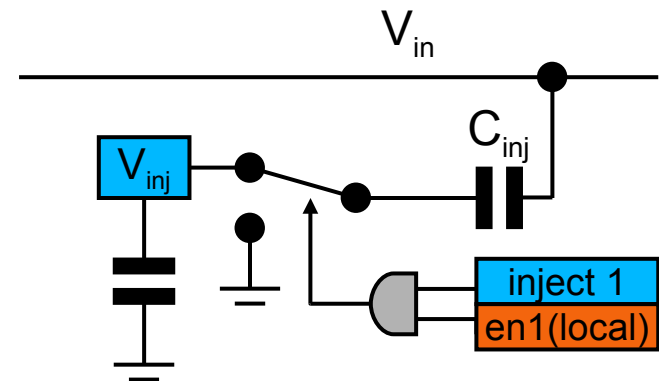
- Monbus: Measure detector leakage, measure I_{leak} , I_{inj} , V_{in}
- Add large array of C_{inj} with cap measurement on chip
- C_{inj} value: $C_{inj} = Q_{max} / DV_{max} \sim 10fC / 1V \sim 10fF$
- Red part is being designed by Mannheim

Circuit to measure C_{inj} precisely

Detail: Injection via Voltage Step

- Goals:
 - Bipolar pulses (pos. and neg. Charges)
 - Large voltage steps (less sensitive to noise in V_{inj})
 - PMOS switches for radiation hardness
 - Switchable C_{inj} for adjustable range (2-10fC)
 - Short pulses (some ns)
- General Problems:
 - Charge injection
 - Bipolar pulses with PMOS
 - Need a good reference/ground voltage

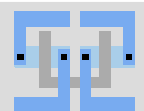
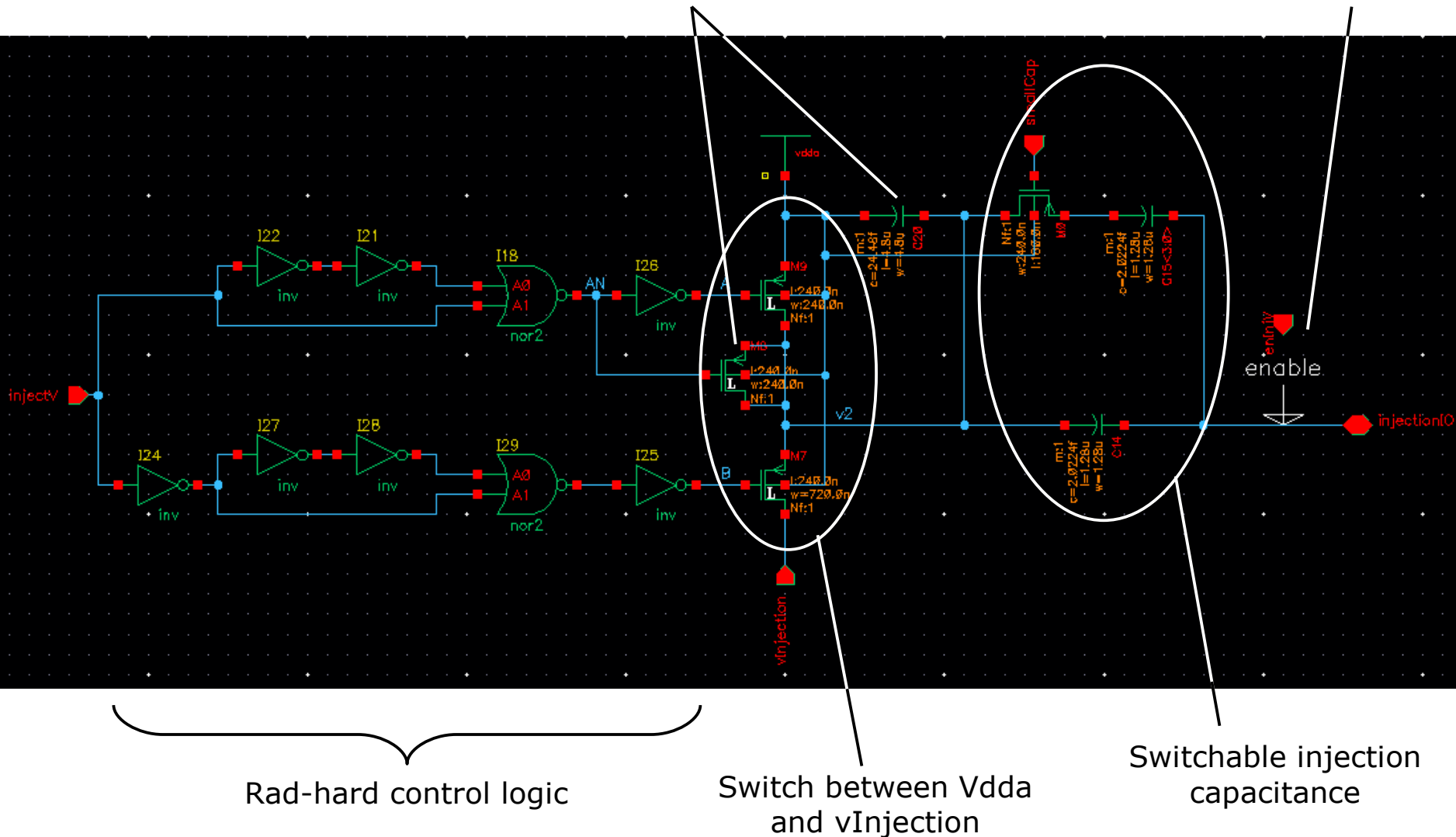
=> Switches tricky, design carefully



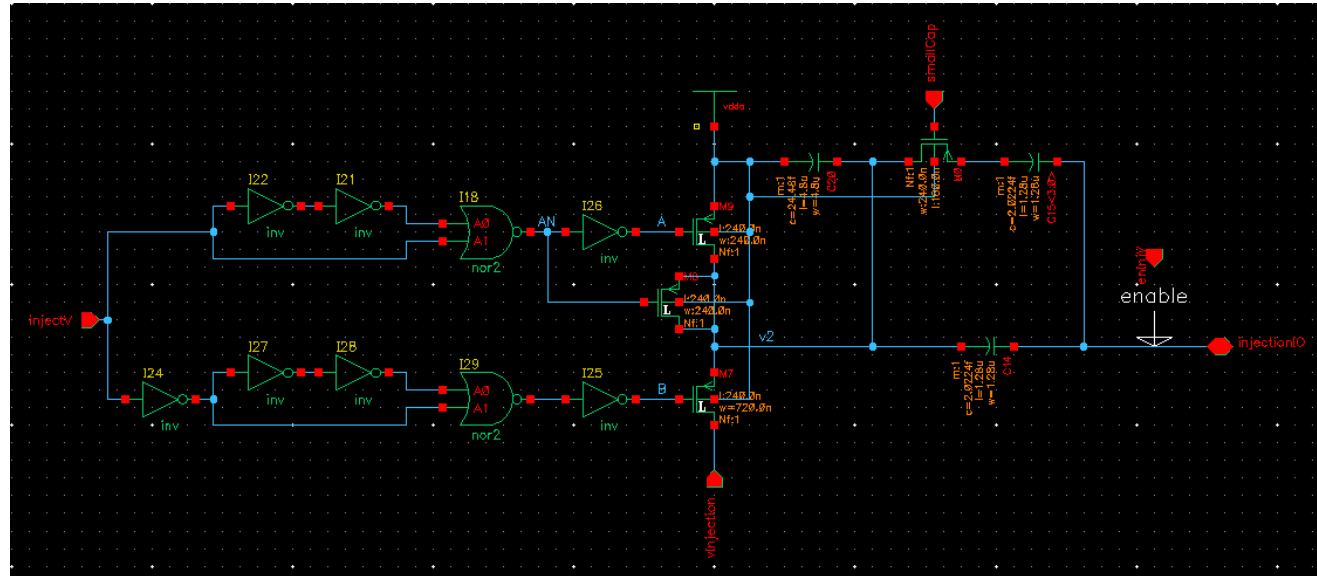
Schematic

Reduce/compensate charge injection

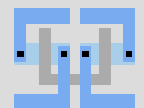
Type of MOS switch depends on input DC level of preamplifier



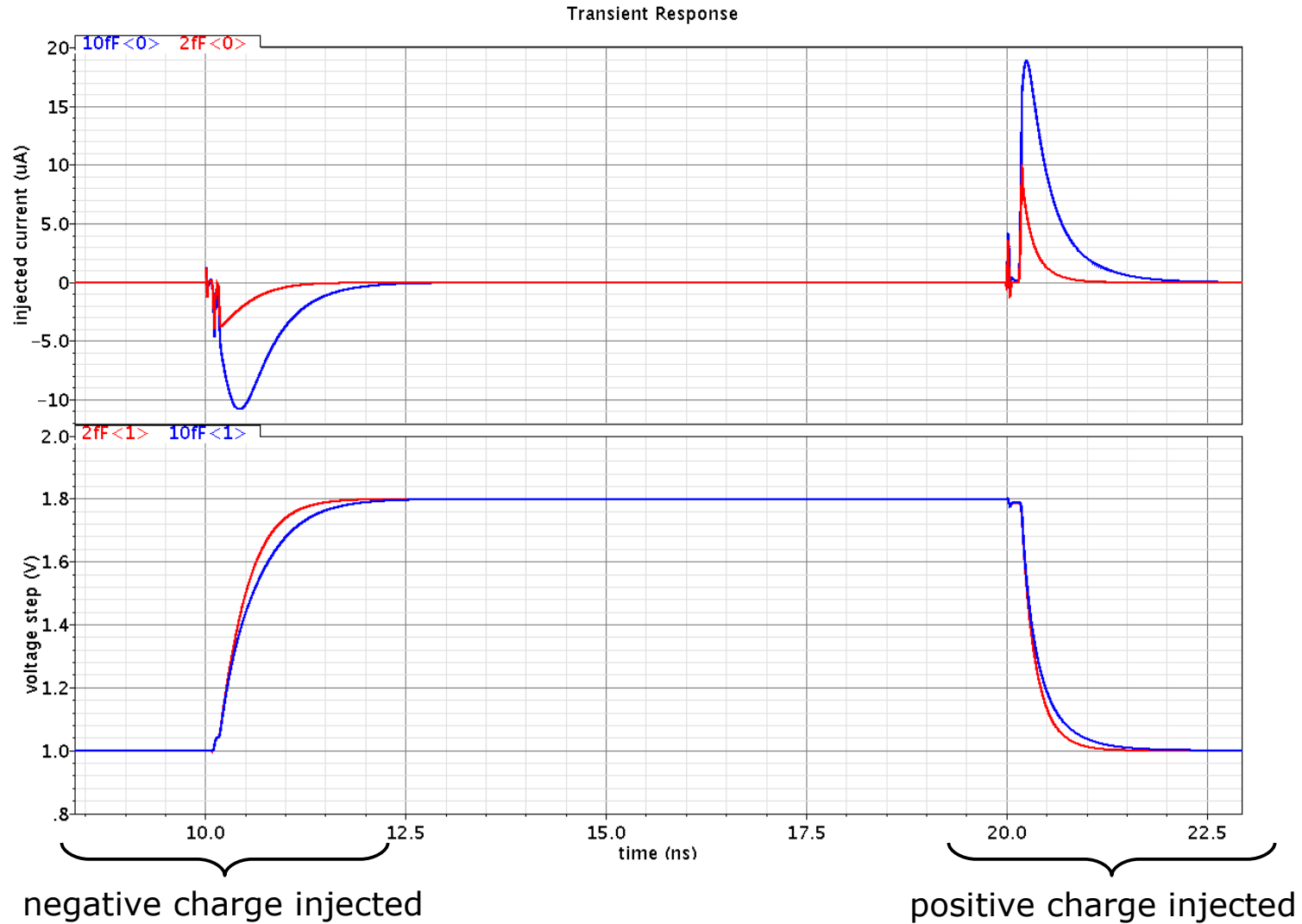
Design Aspects



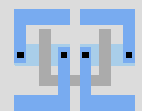
- Only PMOS switches
- Bipolar pulses possible
- Charge injection:
 - No problem with posedge (pos. charge injected doesn't matter).
 - Compensation for negedge (intentionally over-compensated)
- Especially delayed control signals needed
- Low threshold transistors for large output range
- Control logic can be actualized using rad-hard standard cells
- Critical point: Need a good reference voltage (here Vdda)
- Simulation results: Fast and exact (see next slices)



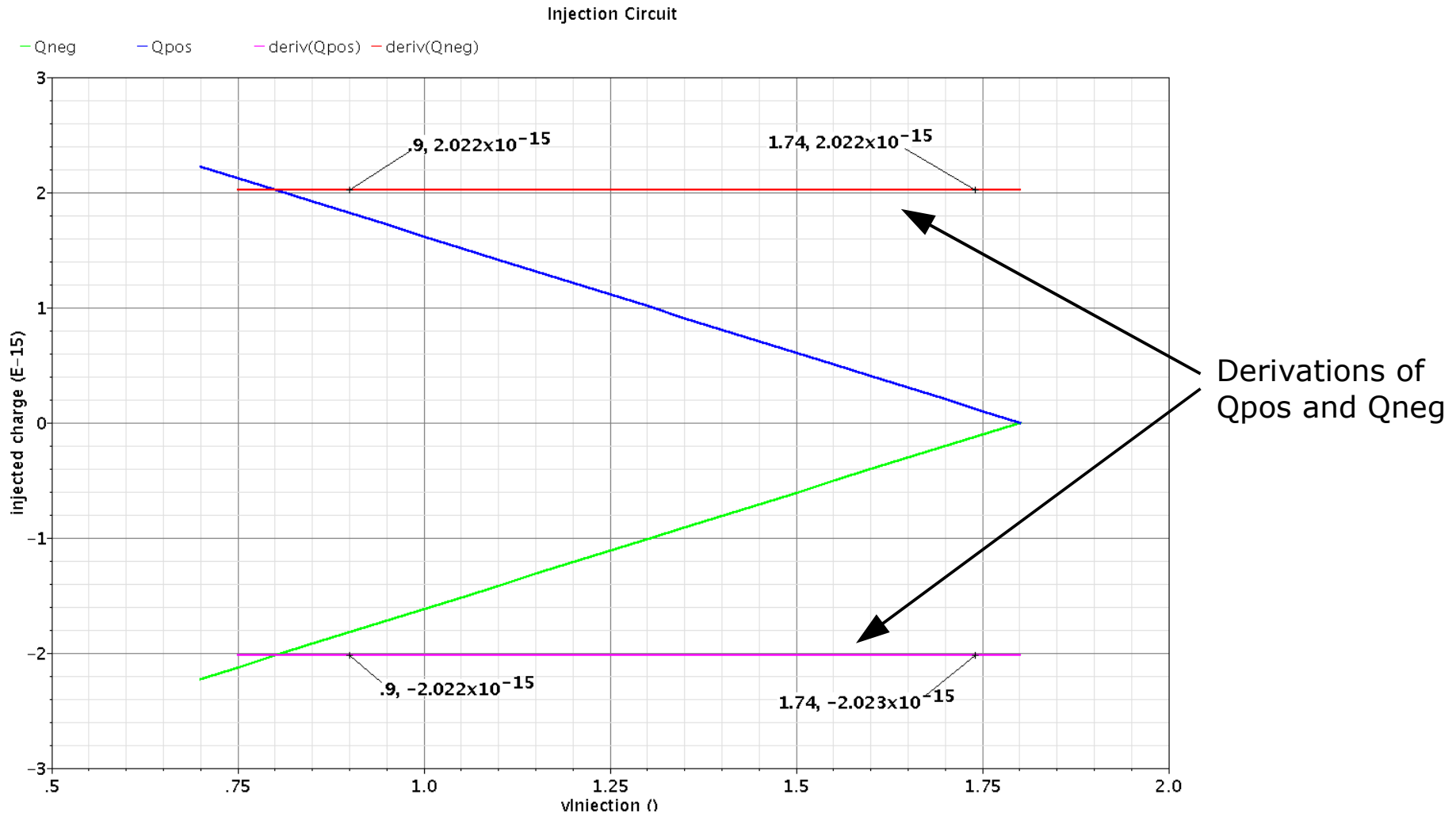
Transient Simulation



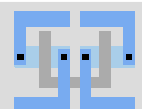
=> No over-/undershooting of voltage step due to charge injection, pulse length <3ns



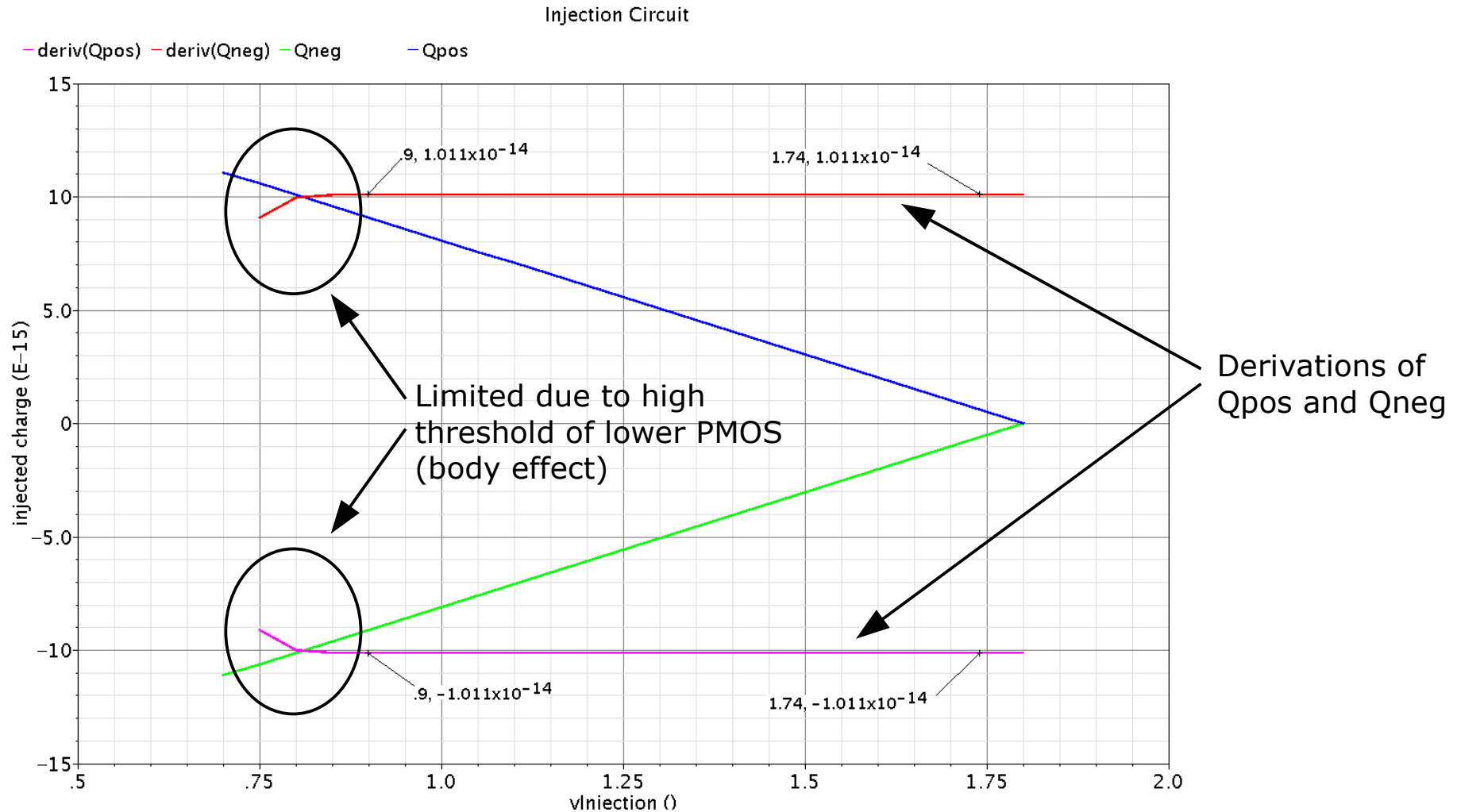
Injected Charge: switch off - small capacitance



**Capacitor 2.022fF => between 900mV and 1.74V simulated error $\leq 0.05\%$
(max. step 1.74V limited due to charge injection)**



Injected Charge: switch on - large capacitance



Capacitor 10.11fF => between 900mV and 1.74V simulated error <= 0.09%

Summary

- **Bipolar** pulses
- **Rad-hard** design
- Possible **injection steps 0.06 - 900mV**
 - Fine steps: $Q_{\text{injected}} = \pm(0.03 - 1.8\text{fC})$, resolution: 2fC/V
 - High range: $Q_{\text{injected}} = \pm(0.15 - 9.0\text{fC})$, resolution: 10fC/V
 - Any other resolution in-between is easy realizable
- **Max. 0.1% (simulated) deviation** from ideal charge values
- **Fast pulses** (< 3ns)
- Most **critical point**: Good reference voltage needed

